



N-Channel 75-V (D-S) MOSFET

PRODUCT SUMMARY		
$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A)
75	0.010 at $V_{GS} = 10$ V	110

FEATURES

- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance Package

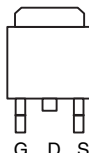


RoHS* COMPLIANT

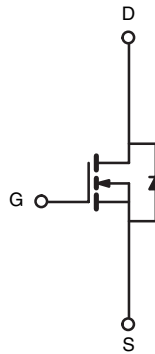
APPLICATIONS

- Automotive
 - Boardnet 42-VEP and ABS
 - Motor Drives
- High Current
- DC/DC Converters

TO-263



Top View



Ordering Information: SUM110N08-10
 SUM110N08-10-E3 (Lead (Pb)-free) N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25$ °C, unless otherwise noted			
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	75	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 175$ °C)	I_D	$T_C = 25$ °C	110
		$T_C = 125$ °C	63 ^a
Pulsed Drain Current	I_{DM}	350	A
Avalanche Current	I_{AR}	75	
Repetitive Avalanche Energy ^a	E_{AR}	280	mJ
Maximum Power Dissipation ^a	P_D	$T_C = 25$ °C	200 ^b
		$T_A = 25$ °C ^c	3.7
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Maximum Junction-to-Ambient	R_{thJA}	40	°C/W
Maximum Junction-to-Case	R_{thJC}	0.75	

- Notes:
- Duty cycle ≤ 1 %.
 - See SOA curve for voltage derating.
 - When mounted on 1" square PCB (FR-4 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply

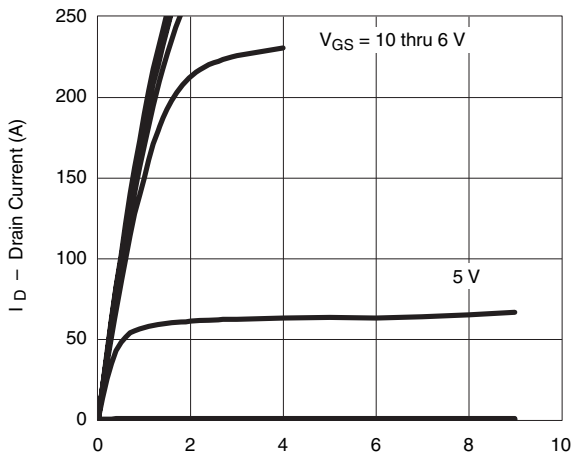
SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{DS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	75			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2.5		4.0	
Gate Body Leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = \pm 20\text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 75\text{ V}, V_{GS} = 0\text{ V}$			1	μA
		$V_{DS} = 75\text{ V}, V_{GS} = 0\text{ V}, T_J = 125\text{ }^\circ\text{C}$			50	
		$V_{DS} = 75\text{ V}, V_{GS} = 0\text{ V}, T_J = 175\text{ }^\circ\text{C}$			250	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}, V_{GS} = 10\text{ V}$	120			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 30\text{ A}$		0.0055	0.010	Ω
		$V_{GS} = 10\text{ V}, I_D = 30\text{ A}, T_J = 125\text{ }^\circ\text{C}$			0.0185	
		$V_{GS} = 10\text{ V}, I_D = 30\text{ A}, T_J = 175\text{ }^\circ\text{C}$			0.0245	
Forward Transconductance	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 30\text{ A}$	30			S
Dynamic^b						
Input Capacitance	C_{iss}	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		5250		pF
Output Capacitance	C_{oss}			700		
Reverse Transfer Capacitance	C_{rss}			310		
Total Gate Charge ^c	Q_g	$V_{DS} = 35\text{ V}, V_{GS} = 10\text{ V}, I_D = 110\text{ A}$		90	165	nC
Gate-Source Charge ^c	Q_{gs}			24		
Gate-Drain Charge ^c	Q_{gd}			27		
Turn-On Delay Time ^c	$t_{d(on)}$	$V_{DD} = 35\text{ V}, R_L = 0.4\text{ }\Omega$ $I_D \cong 110\text{ A}, V_{GEN} = 10\text{ V}, R_g = 2.5\text{ }\Omega$		20	30	ns
Rise Time ^c	t_r			100	150	
Turn-Off Delay Time ^c	$t_{d(off)}$			45	70	
Fall Time ^c	t_f			75	115	
Source-Drain Diode Ratings and Characteristics ($T_C = 25\text{ }^\circ\text{C}$)^b						
Continuous Current	I_S				110	A
Pulsed Current	I_{SM}				350	
Forward Voltage ^a	V_{SD}	$I_F = 110\text{ A}, V_{GS} = 0\text{ V}$		1.0	1.5	V
Reverse Recovery Time	t_{rr}	$I_F = 85\text{ A}, di/dt = 100\text{ A}/\mu\text{s}$		75	120	ns
Peak Reverse Recovery Current	$I_{RM(REC)}$			3.5	7	A
Reverse Recovery Charge	Q_{rr}			0.13	0.30	μC

Notes:

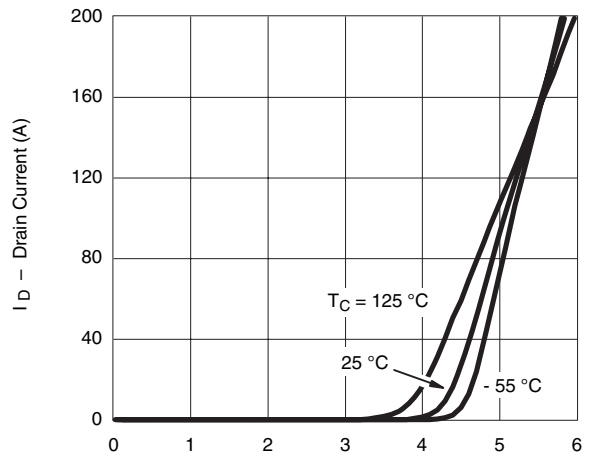
- Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.
- Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

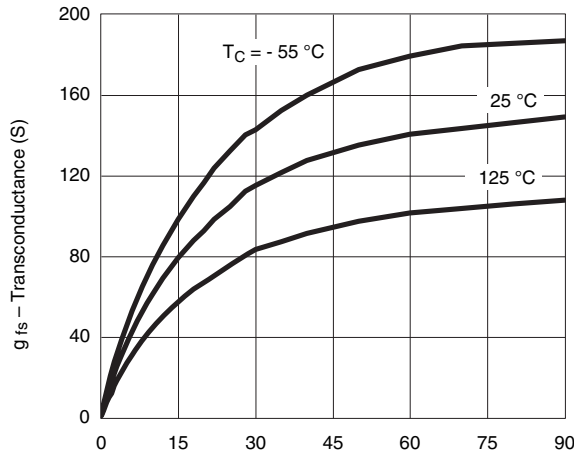
TYPICAL CHARACTERISTICS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



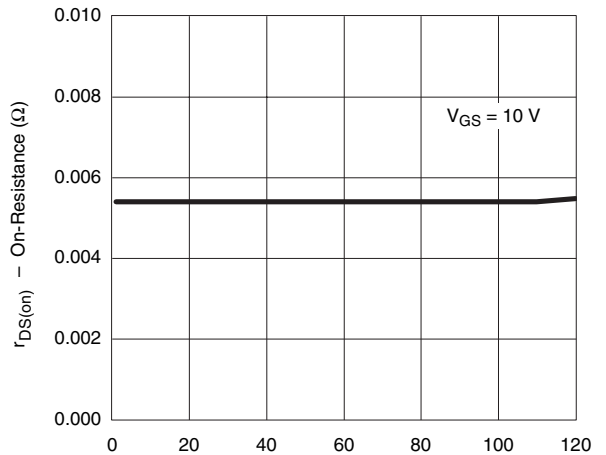
$V_{GS} = 10$ thru 6 V
5 V
Output Characteristics



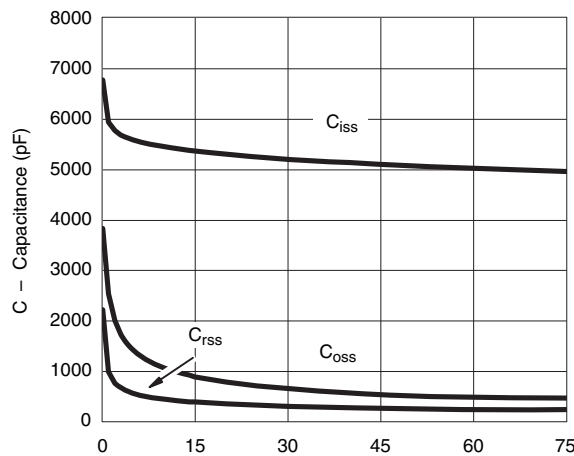
$T_C = 125\text{ }^\circ\text{C}$
 $25\text{ }^\circ\text{C}$
 $-55\text{ }^\circ\text{C}$
Transfer Characteristics



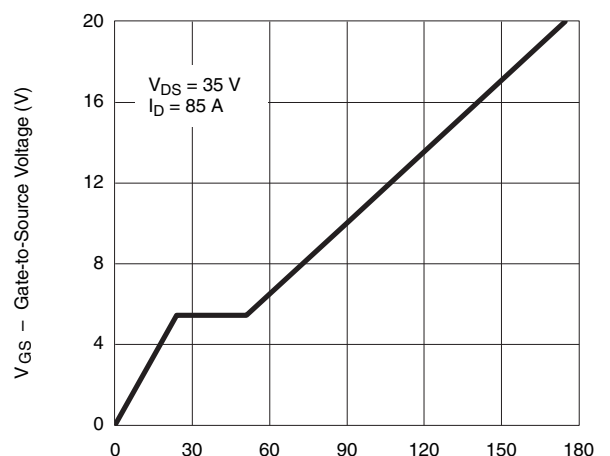
$T_C = -55\text{ }^\circ\text{C}$
 $25\text{ }^\circ\text{C}$
 $125\text{ }^\circ\text{C}$
Transconductance



$V_{GS} = 10\text{ V}$
On-Resistance vs. Drain Current



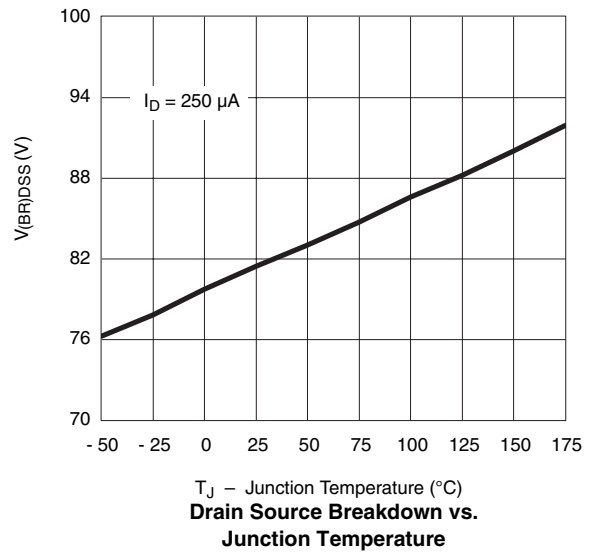
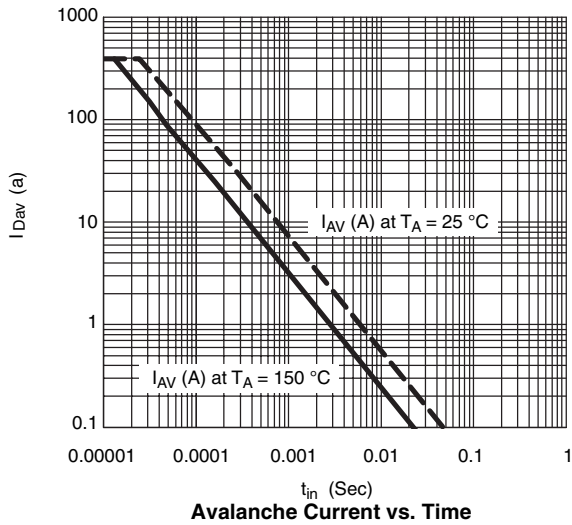
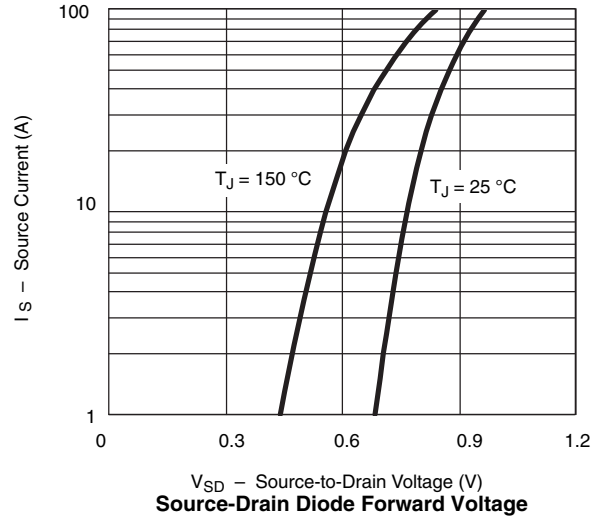
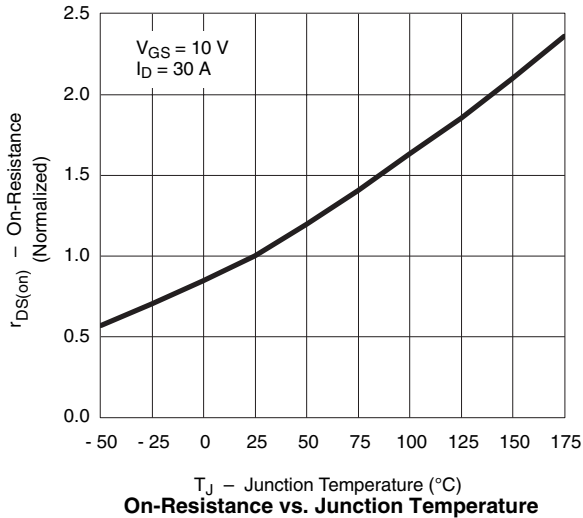
C_{iss}
 C_{oss}
 C_{rss}
Capacitance



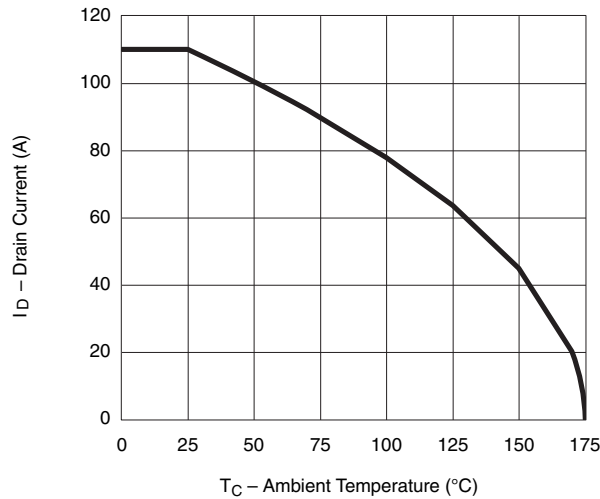
$V_{GS} = 35\text{ V}$
 $I_D = 85\text{ A}$
Gate Charge



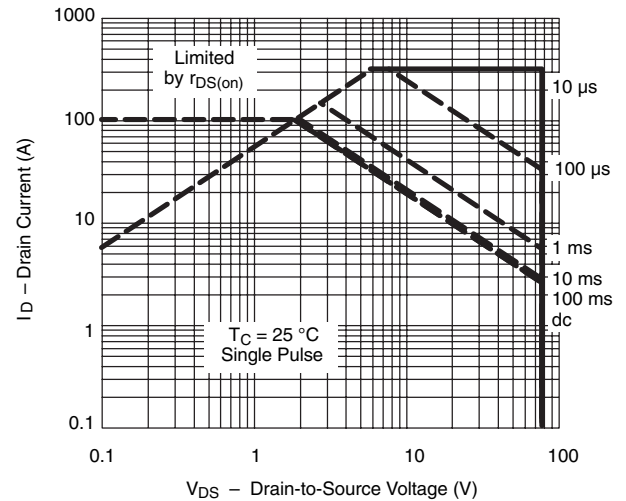
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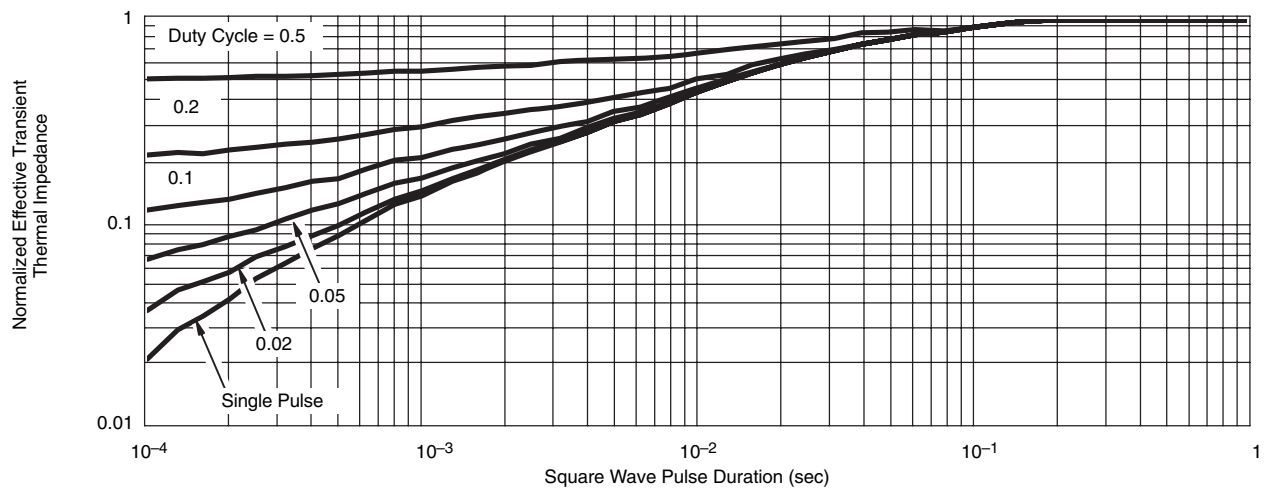
TYPICAL CHARACTERISTICS $T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted



Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

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